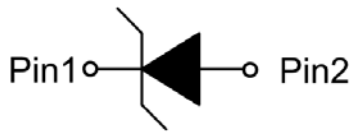


1- Line, Uni-directional, Transient Voltage Suppressor



SOD-523

Features

- Stand-off voltage: 27V Max
- Transient protection for each line according to
IEC61000-4-2(ESD): $\pm 30\text{kV}$ (contact)
IEC61000-4-5(surge): 6A (8/20 μs)
- Low leakage current:
- Ultra low clamping voltage
- RoHS Compliant

Applications

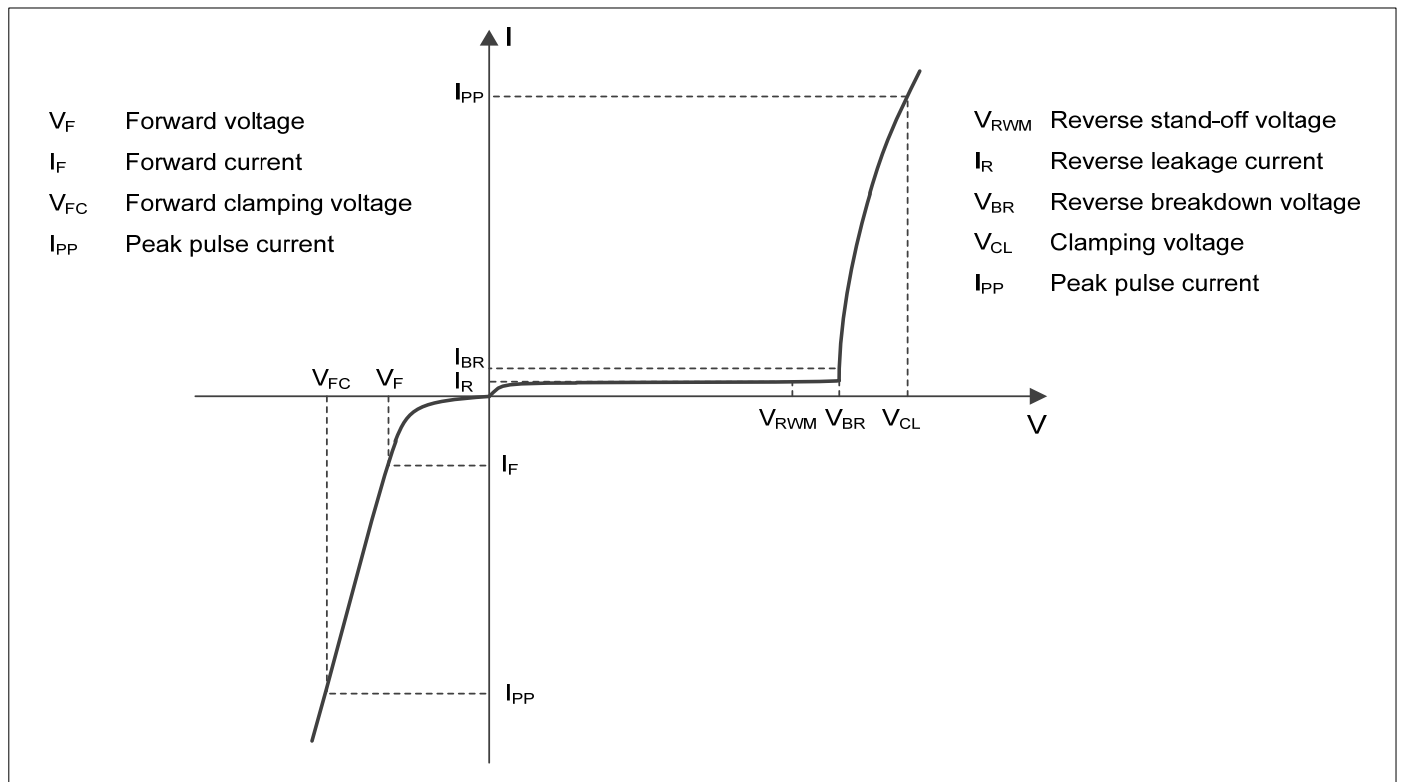
- Cellular Handsets and Accessories
- Personal Digital Assistants
- Notebooks and Handhelds
- Portable Instrumentation
- Digital Cameras
- Peripherals
- Audio Players

Mechanical Data

- Package: SOD-523
- Lead Finish: Matte Tin
- Case Material: "Green" Molding Compound
- Marking Information: See Below



■Definitions of electrical characteristics





ESD27VD5

■Maximum Ratings

PARAMETER	SYMBOL	LIMITS	UNIT
Peak pulse power ($t_p = 8/20\mu s$)	P_{pk}	300	W
Peak pulse current ($t_p = 8/20\mu s$)	I_{PP}	6	A
ESD according to IEC61000-4-2 air discharge	V_{ESD}	± 30	KV
ESD according to IEC61000-4-2 contact discharge		± 30	
Junction temperature	T_J	-55~125	°C
Storage temperature	T_{STG}	-55~150	°C

■Electrical Characteristics ($T_a=25^\circ C$ Unless otherwise specified)

PARAMETER	Symbol	UNIT	Conditions	Min	Typ	Max
Reverse maximum working voltage	V_{RWM}	V				27
Reverse leakage current	I_R	μA	$V_{RWM} = 27V$			0.1
Reverse breakdown voltage	V_{BR}	V	$I_{BR} = 1mA$	28		39
Clamping voltage ²⁾	V_{CL}	V	$I_{PP} = 1A, t_p = 8/20\mu s$			43
		V	$I_{PP} = 6A, t_p = 8/20\mu s$			50
Forward voltage	V_F	V	$I_F = 10mA$			1.2
Junction capacitance	C_J	pF	$V_R = 0V, f = 1MHz$		31	

Notes:

(1). TLP parameter: $Z_0 = 50\Omega$, $t_p = 100ns$, $t_r = 2ns$, averaging window from 60ns to 80ns. R_{DYN} is calculated from 4A to 16A.

(2). Non-repetitive current pulse, according to IEC61000-4-5.

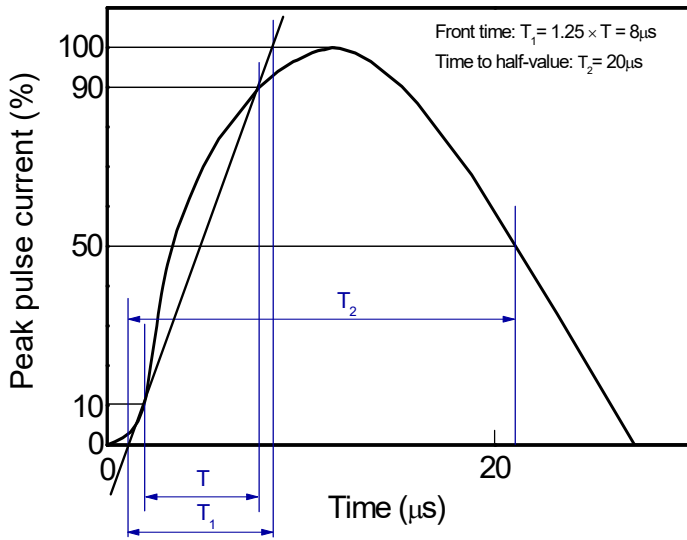
■Ordering Information (Example)

PREFERRED P/N	PACKING CODE	UNIT WEIGHT(mg)	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
ESD27VD5	F2	Approximate 2	8000	80000	320000	7" reel

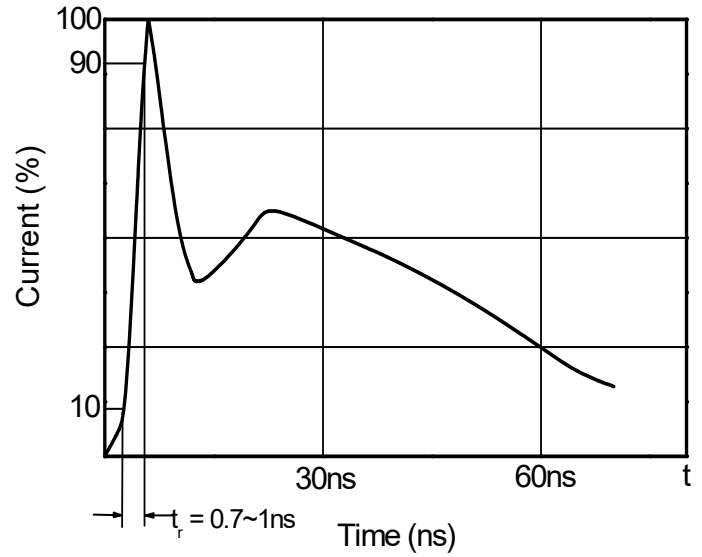


■ Characteristics (Typical)

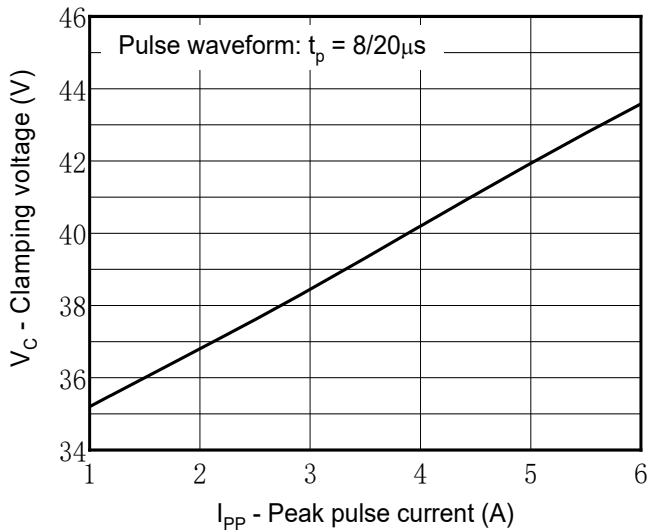
8/20 μ s waveform per IEC61000-4-5



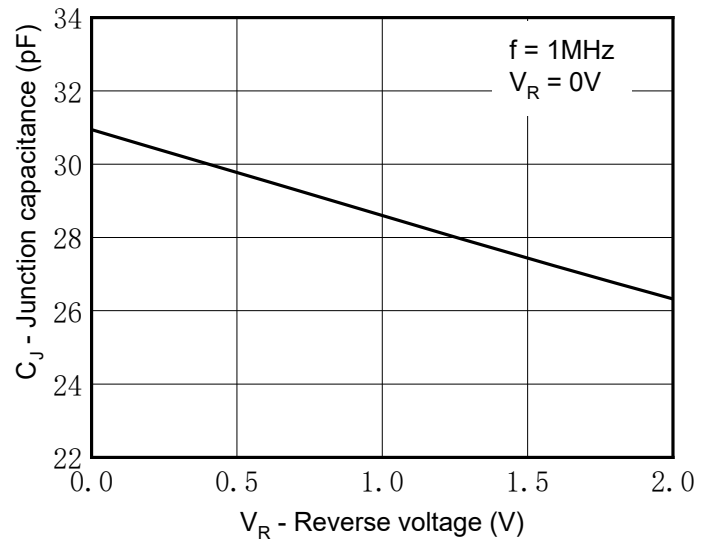
Contact discharge current waveform per IEC61000-4-2



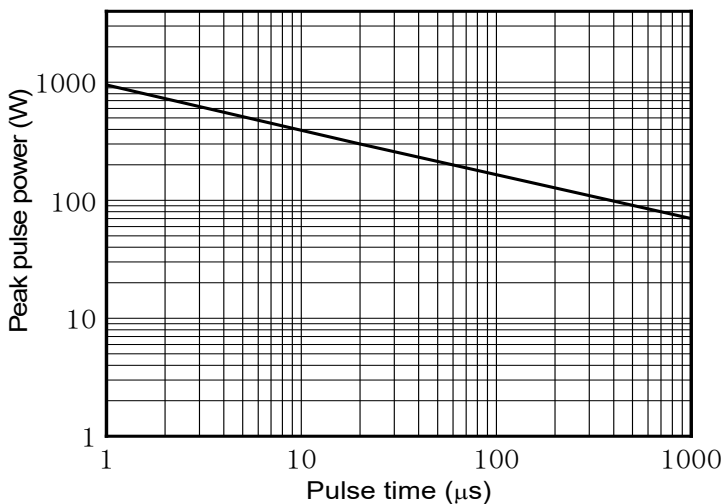
Clamping voltage vs. Peak pulse current



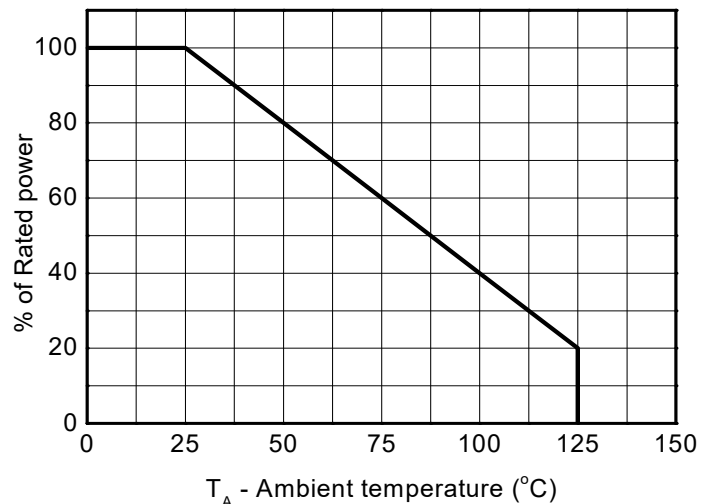
Capacitance vs. Reverse voltage



Non-repetitive peak pulse power vs. Pulse time

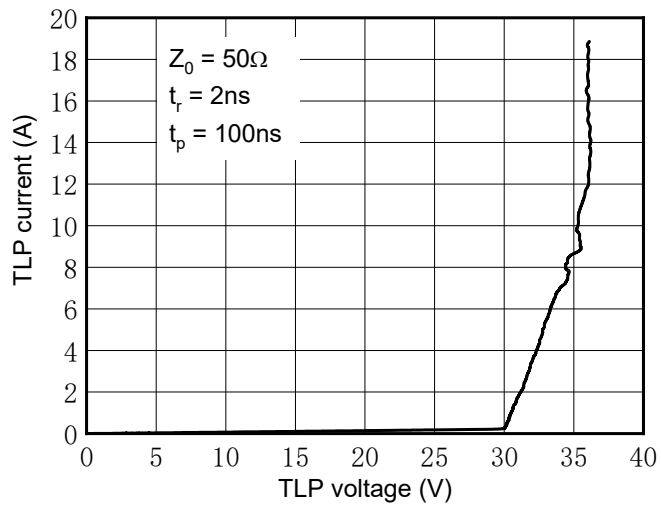


Power derating vs. Ambient temperature

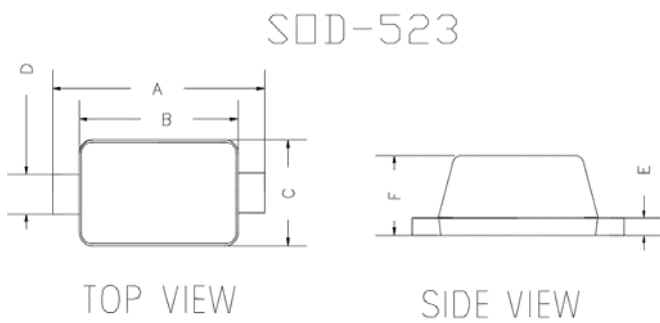




TLP Measurement

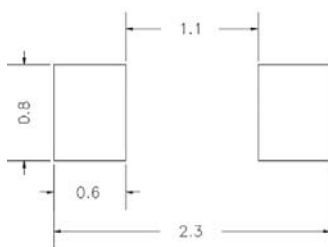


■ Outline Dimensions



DIMENSIONS				
DIM	INCHES		MM	
	MIN	MAX	MIN	MAX
A	0.059	0.067	1.500	1.700
B	0.043	0.051	1.100	1.300
C	0.028	0.035	0.700	0.900
D	0.010	0.014	0.250	0.350
E	0.002	0.008	0.050	0.200
F	0.020	0.028	0.500	0.700

■ Soldering Footprint



UNIT: mm

SUGGESTED SOLDER PAD LAYOUT



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